### Connect with IoT

# **ROHM IoT Solutions**

Creating novel devices and applications. Semiconductor solutions that expand the possibilities of IoT. Supporting manufacturing and contributing to society through innovative technologies.







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# Adding sensor, control, and network algorithms **IOT Initiatives**

ROHM GROUP

LAPIS

Achieving IoT, in which devices are connected to the internet, involves sensors for detecting conditions, MCUs for processing sensor information, and networks for sharing and transmitting data. For many years, ROHM has been working on developing products and proposing solutions for creating sensor networks across the entire ROHM group.For example, one area where IoT is expected to make a significant impact is long-term equipment monitoring for machine health and infrastructure. Analyzing sensor data and creating algorithms to detect abnormalities will make it possible to predict breakdowns and accidents before they occur. We believe that new systems and services such as this will emerge as networks continue to evolve and expand, driving ROHM to leverage its resources and technologies to contribute to meeting the needs of the market and society.

Kīonix

# ROHM provides total solutions including sensors and wireless communication required for IoT

### **ROHM OPEN SOLUTIONS LAB**

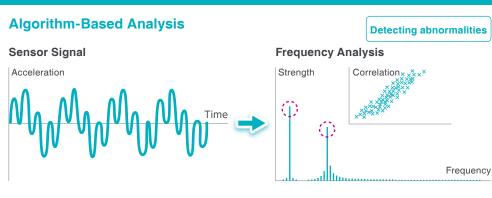


ROHM Open Solutions Lab opened this spring as a communications space created with the goal of creating new solutions with customers by utilizing open source hardware and software.

Kyoto Technology Center

# Cloud

#### Gateway



Detected abnormalities are sent to a gateway to be used for monitoring, operation, prevention, and improvement

#### ROHM IOT SOLUTIONS LAB Factory Area



#### Abnormal Barometric Pressure Detection

Enables monitoring of the current value and changes in atmospheric pressure.

Barometric pressure sensor, Wi-SUN communication module

#### BAutomatic Dimmer Control

Detects brightness and automatically monitors dimming and lighting conditions. Ambient light sensor, LED driver

#### **D**Color Identification Management

Detects colors and monitaes misuse and status.

Color sensor, Wi-SUN communication module

#### C Abnormal Vibration Detection

Monitors operating status. Allows for abnormality detection and predictive management.

Accelerometer, EnOcean® wireless communication module, high performance and ultra-low-power MCU

#### A Lighting Control

Performs indoor/outdoor operation and monitoring of lighting pattern and color temperature.

Wi-SUN communication module

#### Contemporature/Humidity Management

Detects the humidity and temperature and monitors the indoor environment.

EnOcean® temperature/humidity sensor modules

#### BPresence Detection Control

Detects the presence of people and performs device operation. Supports wireless communication using energy harvesting technology. EnOcean<sup>®</sup> wireless module

#### Open/Close Monitoring

Detects the opening/closing of doors and windows and manages status. Monitors door locks and manages indoor traffic. EnOcean® magnetic contact module

#### ROHM IOT SOLUTIONS LAB Home Area



### Connect with IoT



Wi-Fi Module Evaluation Kits BP359x series

The BP359x series integrates ROHM's BU1805GU system IC and is certified under both the IEEE802.11b/g/n standard and Japan's Radio Law. Pre-tuned wireless characteristics and built-in antenna allow customers to skip radio waves and immediately begin evaluation and development without complicated characteristics adjustment.

In addition, the optimized antenna configuration eliminates the need for high-frequency designs.

#### UART

 Onboard BS-232C I/O USB-UART conversion Supports USB BUS power

\*BP395D can be used with both BP3591 and BP3599

#### Wireless LAN Module Lineup

(When using BP3591 perform startup with the flash memory on BP359D. When using BP3599 perform startup using the flash memory on BP3599.)





All necessary documents and software can be downloaded from ROHM's website

#### Wi-Fi Support Page

URL: http://www.rohm.com/web/global/wireless-lan-support



### **EnOcean® Evaluation Kit**

EDK 400J

BP359F

EnOcean's module is an ultra-low-power wireless communication device that can be installed virtually anywhere, featuring a battery-less design that requires no maintenance.

The lack of wiring allows it to be introduced even in hotels and important cultural institutions. The EDK 400J evaluation kit is a programming kit that facilitates application development.

#### **Bundled Products (i.e. EDK 400J)**

- PTM 210J (Switch Module)
- USB 400J (Receiver USB Module)
- PTM 430J (Electronic Circuit Board for Switch Module)
- ECO 200 (Electromagnetic Induction Element for Switch Module)
- STM 431J (Temperature Sensor Module)
- STM 400J (Wireless Energy Harvesting Module)\*
- EOP 350 (Programming Board)\*2
- USB Cable (For connecting the EOP 350 to a PC)
- \*1: STM 400J within the EDK 400J is mounted on a dedicated board for connecting to EOP 350. \*2: Used when rewriting firmware for STM 431J and STM 400J.

#### Dolphin V4 API (S/W)

Library files

EDK 400J is available for purchase.

 Manual on peripheral functions Sample source

#### Dolphin V4 Suite (S/W)

A software group for performing program writing, device settings, and chip calibration.

Keil integrated development environment (uVision)

Together with Dolphin V4 API/Suite (S/W), allows for series firmware development including original firmware coding, compiling, and writing.

#### Dolphin View

In evaluation tool for evaluating and analyzing EnOcean® wireless signals.					
Frequency	Target Country/Region	EDK Series			
920MHz	Japan (ARIB STD-T-108)	EDK 400J			
902MHz	North America (FCC PART 15)	EDK 350U			
868MHz	EU, India (ETSI EN 300 220)	EDK 350			
Note: Each product will support a different frequency based on country/region					

#### **Dedicated EnOcean® Site**

URL: http://www.rohm.com/web/global/enocean

# Wi-SUN USB Dongle

ROHM's BP35C2 is a USB dongle that integrates the BP35C0 featuring class-leading\* reception sensitivity.

The built-in antenna, pre-adjusted wireless characteristics, Radio Law certification, and installed MAC addresses make it possible to easily construct a Wi-SUN environment by simply connecting to the USB port of IoT equipment such as home gateways.

#### **BP35C2 USB Dongle** • Host CPU I/F: USB • Size: 21.4×49.7×8.5 Supply voltage: 4.5 to 5.5V (single power supply) • Operating Temperature: -20 to +50 Onboard Wi-SUN Module BP35C0 Built-in system LSI: ML7416N ROHM · • 920MHz band transceiver type Compatible with ARIB STD-T108 Supply voltage: 2.6 to 3.6V (single power supply) Host CPU I/F: UART SMD Type Part No. USB Dongle Type Part N

				<b>v</b> <i>s</i> .		
1	920MHz	Japan (ARIB STD-T-108)	BP35C0	BP35C2		
	915MHz	North America (FCC PART 15)	Under Planning	Under Planning		
	868MHz	EU, India (ETSI EN 300 220)	Under Planning	Under Planning		
Note: Each product will support a different frequency based on country/region.						

#### Ideal for compact communication equipment such as **HEMS controllers and consumer appliances**

The BP35C0 is a compact surface-mount Wi-SUN module (utilizing external antenna) equipped with an MCU, 920MHz band radio communication function (RF) featuring class-leading\* reception sensitivity, and LAPIS Semiconductor's ML7416N wireless communication IC with large memory capacity optimized for Wi-SUN.

Note: This is product limited to Japan



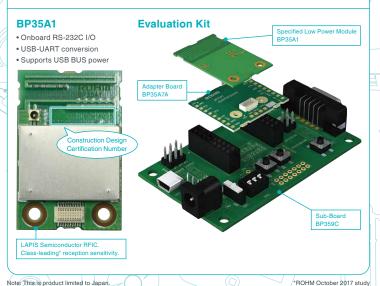
In addition, support for HAN and Wi-SUN B route profile is provided in a class-leading\* small 15mm×19mm size, making it ideal for HEMS controllers and home appliances. Naturally, the dongle conforms to the ARIB STD-T108 standard, ensuring compliance under Japan's Radio Law.

# **MCU-Equipped RF Module**

\*ROHM October 2017 study

The BP35A1 is a 920MHz specified low power wireless module that supports Wi-SUN (Wireless Smart Utility Network). Incorporating a 32bit high power MCU enables adoption in a variety of HEMS devices.

In addition, the user-friendly module is Radio Law certified (Japan) and includes firmware is compatible with the Wi-SUN standard ideal for IoT/M2M/HEMS/BEMS equipment. It is also registered as a CTBU (Certified Test Bed Unit) recognized by the Wi-SUN Alliance as a reference standard, playing the role of a reference unit for Wi-SUN communication.









#### USB type enables immediate evaluation via PC Bluetooth<sup>®</sup> USB Dongle

#### MK71251-02B-USB-

corestaff DIRECT

We offer tools for evaluating and developing applications using LAPIS Semiconductor's Bluetooth<sup>®</sup> module. In addition to a smartphone application (BLE Tool) that facilitates the development of communication devices with a smartphone, GUI tools for easy PC settings, and USB-type evaluation boards that enable immediate development using a PC, we contribute to customer development with a serial communication SDK, beacon SDK, and Beacon Tool smartphone application optimized for beacon development.

#### MK71251-02B-USB-EK (USB Dongle)

MK71251-02B-USB-EK (USB Dongle) are also compliant with the radio laws in the US (FCC), Canada (IC), and the EU (CE). And even in wearables and other products expected to be adopted overseas, it will be possible to broadcast radio waves as in Japan.



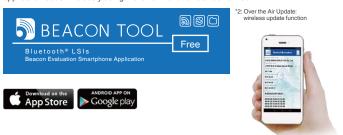
#### Numerous Development Support Tools

The BLE TOOL smartphone app for Bluetooth<sup>®</sup> low energy control enables easy verification of Bluetooth<sup>®</sup> low energy device communication. In addition to 7 standard Bluetooth<sup>®</sup> SIG profiles<sup>\*1</sup> and services, users can perform evaluation and communication demos of LAPIS Semiconductor's original VSSPP (serial port profile) and VSP (acceleration profile).



\*1: HRP, HTP, BLP, GLP, ESS, BAS, DIS

# Using the BEACON TOOL smartphone app for Bluetooth<sup>®</sup> low energy beacons makes it possible to evaluate the beacon device functionality of the MK71251-02B. In addition to evaluating beacon packet reception and display, operations such as updating of the iBeacon application code wirelessly using the OAU\*<sup>2</sup> function can be verified.



# Integrates the industry's smallest SMD module BP35C0 BP35C0-Equipped Adapter Board BP35C0-T01

ROHM's BP35C0-T01 evaluation board with built-in compact Wi-SUN compatible general-purpose module (BP35C0) supports connection to the BP359C.

Wi-SUN firmware is installed in the MCU, and the board has achieved certification under Japan's Radio Law in an industry-small\* form factor (15mm×19mm), making it ideal for compact communication equipment such as HEMS controllers and consumer appliances utilizing Wi-SUN.

#### BP35C0-T01

Adapter board equipped with BP35C0

#### **BP359C**

Conversion board for UART I/F

Onboard RS-232C I/O

USB-UART conversion

Note: This is product limited to Japan

Supports USB BUS power



\*ROHM October 2017 study

All necessary documents and software can be downloaded from ROHM's website

#### Wi-SUN Board Page (Japanese)

URL: http://micro.rohm.com/jp/download\_support/wi-sun/

Wireless Communication/ MCU Evaluation Kits

## **On-Chip Debug Emulator**

uEASE/nanoEAS

MOUSER

Lineups other than

wireless communication devices

offered, including

LAPIS Semiconductor's program development support system consists of hardware and software tools that actively support program development. The software tools feature a user-friendly graphical user interface (GUI) that facilitate operation, making it possible to perform tasks more efficiently - from program creation and build (object creation) to debugging.

#### MCU with On-Chip Debugger uEASE

uEASE is a standard on-chip emulator that supports all LAPIS Semiconductor 8bit/16bit flash MCUs. Size:  $50.0 (D) \times 90.0 (W) \times 17.0 mm (H)$  Weight: 50g

#### MCU with On-Chip Debugger nanoEASE

nanoEASE, which supports LAPIS Semiconductor 8bit/16bit flash MCUs (generate an internal voltage) that operate from a single power supply, is a more compact on-chip debug emulator than uEASE. Size: 50.0 (D)  $\times$  60.0 (W)  $\times$  7.0mm (H) Weight: 15g



# ROHM Group MCUs for IoT

### Low Power Microcontrollers

LAPIS Semiconductor's low-power MCUs achieve class-leading\* performance by leveraging original low power technologies cultivated over many years.

For IoT, high performance a CMOS MCUs equipped with a proprietary 16bit RISC-type U16 core and 32bit ARM<sup>®</sup> Cortex<sup>®</sup>-M0+ are available. Other lineups are offered to meet diverse customer needs, including 'tough' MCUs strong against noise and high-temperature environments.

#### High Performance Ultra-Low Power 16bit MCUs ML620Q503H/ML620Q504H

These high performance 16bit CMOS MCUs integrate a proprietary RISC-type 16bit CPU U16 core. LAPIS Semiconductor was able to improve upon the low power technology of its 8bit U8 Core MCUs while increasing processing power. In addition, current consumption is reduced by optimally combining 3 power down modes, and the broad range of peripherals supports a variety of system requirements.

### High Performance Ultra-Low Power 32bit MCUs ML630Q464/ML630Q466

32bit MCUs ideal for USB data loggers in cold chain applications. Built-in USB2.0, PDF generation function, and LCD driver makes it possible to safely store and transfer log data.

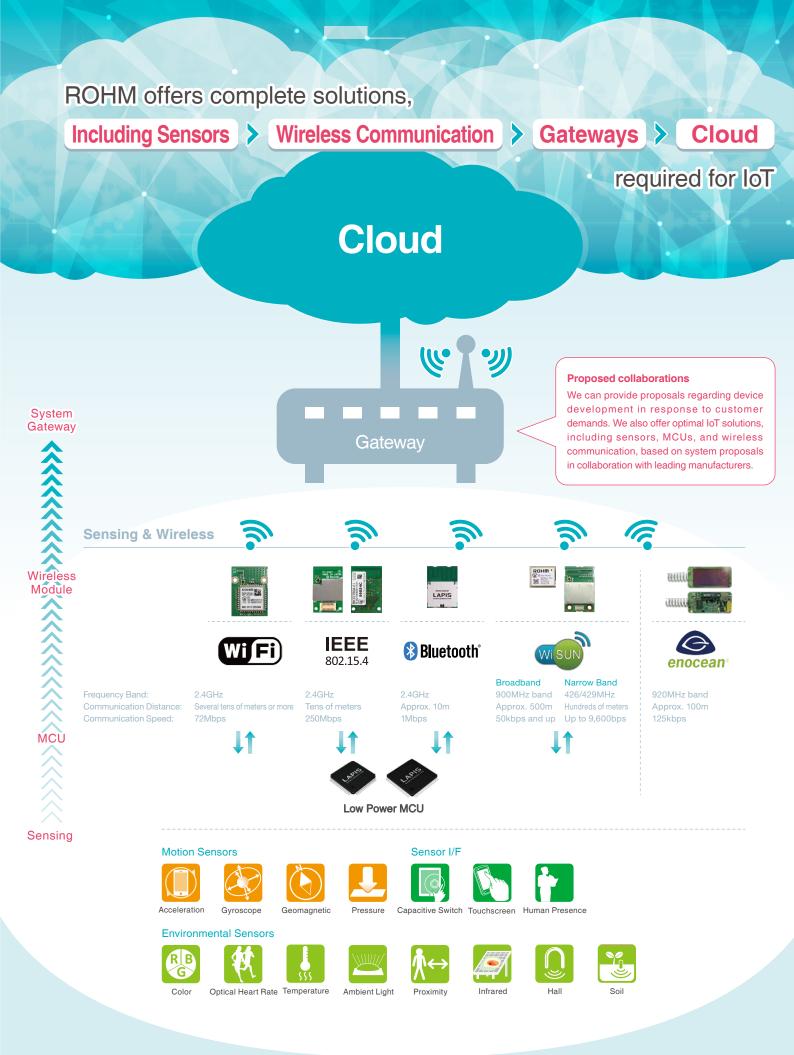
### High Performance Low Power 'Tough' MCUs ML62Q1000 series

High performance 16bit CMOS MCUs utilizing an original U16 Core. This series inherits the superior noise immunity and high temperature characteristics of LAPIS Semiconductor's market-proven 'tough' MCUs. Superior processing performance with abundant peripherals is achieved while maintaining low power consumption. The lineup includes general-purpose high performance types with program memory ranging from 16KB to 256KB as well as models that integrate an LCD driver.



power

\*ROHM October 2017 study



# **X-ON Electronics**

Largest Supplier of Electrical and Electronic Components

Click to view similar products for RF Development Tools category:

Click to view products by ROHM manufacturer:

Other Similar products are found below :

MAAP-015036-DIEEV2 EV1HMC1113LP5 EV1HMC252AQS24 EV1HMC6146BLC5A EV1HMC637ALP5 EVAL01-HMC1048LC3B EVAL01-HMC661LC4B EVAL-ADF7020-1DBZ4 EVAL-ADF7020-1DBZ5 EVAL-ADF7020-1DBZ6 EVAL-ADF7021DB9Z EVAL-ADF7021DBJZ EVAL-ADF7021DBZ2 EVAL-ADF7021DBZ6 EVAL-ADF7021-NDBZ2 EVAL-ADF7021-VDB3Z EVAL-ADF7023DB3Z EVAL-ADF7023-JDB3Z EVAL-ADF70XXEKZ1 EVAL-ADF7241DB1Z F0440EVBI F1241EVBI F1423EVB-DI F1423EVB-SI F1701EVBI F1751EVBI F2250EVBI MICRF219A-433 EV 122410-HMC686LP4E AD6679-500EBZ 126223-HMC789ST89E ADL5363-EVALZ ADL5369-EVALZ 130437-HMC1010LP4E 131352-HMC1021LP4E 131372-HMC951LP4E 130436-HMC1010LP4E DEMOBOARD-U2790B ATR2406-PNQW EKIT01-HMC1197LP7F Si4705-D60-EVB Si4835-Demo LMV228SDEVAL SKYA21001-EVB SMP1331-08-EVB EV1HMC618ALP3 EV1HMC641ALC4 EV1HMC8410LP2F EVAL\_PAN4555ETU EVAL01-HMC1041LC4